TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (Ultra-High-Speed U-MOSIII)

# **TPC8020-H**

High-Efficiency DC/DC Converter Applications
Notebook PC Applications
Portable Equipment Applications

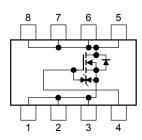
- Small footprint due to a small and thin package
- High-speed switching
- Small gate charge: QSW = 6.9 nC (typ.)
- Low drain-source ON- resistance:  $RDS(ON) = 6.8 \text{ m}\Omega \text{ (typ.)}$
- High forward transfer admittance:  $|Y_{fs}| = 32 S$  (typ.)
- Low leakage current:  $IDSS = 10 \mu A (max) (VDS = 30 V)$
- Enhancement mode:  $V_{th} = 1.1$  to 2.3 V ( $V_{DS} = 10$  V,  $I_{D} = 1$  mA)

## Absolute Maximum Ratings (Ta = 25°C)

Characte	eristic	Symbol	Rating	Unit	
Drain-source voltage		$V_{DSS}$	30	V	
Drain-gate voltage (R	$R_{GS} = 20 \text{ k}\Omega$ )	$V_{DGR}$	30	V	
Gate-source voltage		$V_{GSS}$	±20	V	
Drain current	DC (Note 1)	ID	13	А	
Diam current	Pulsed (Note 1)	$I_{DP}$	52		
Drain power dissipati	on $(t = 10 s)$ (Note 2a)	$P_{D}$	1.9	W	
Drain power dissipation (t = (Note		$P_{D}$	1.0	W	
Single-pulse avalance	he energy (Note 3)	E <sub>AS</sub>	110	mJ	
Avalanche current		I <sub>AR</sub>	13	Α	
Repetitive avalanche	energy Note 2a) (Note 4)	E <sub>AR</sub>	0.084	mJ	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature	range	T <sub>stg</sub>	-55 to 150	°C	

Weight: 0.085 g (typ.)

#### **Circuit Configuration**



Note: For Notes 1 to 4, refer to the next page.

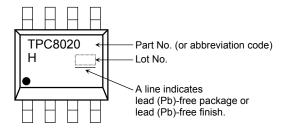
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Handle with care.

#### **Thermal Characteristics**

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R <sub>th (ch-a)</sub>	65.8	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R <sub>th (ch-a)</sub>	125	°C/W

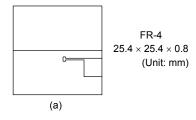
## Marking (Note 5)

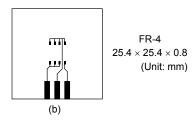


Note 1: The channel temperature should not exceed 150°C during use.

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)



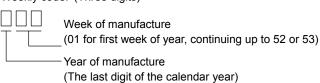


Note 3:  $V_{DD} = 24~V,~T_{ch} = 25^{\circ}C$  (initial), L = 0.5 mH, R<sub>G</sub> = 25  $\Omega,~I_{AR} = 13~A$ 

Note 4: Repetitive rating: pulse width limited by max channel temperature

Note 5: • on the lower left of the marking indicates Pin 1.

\* Weekly code: (Three digits)



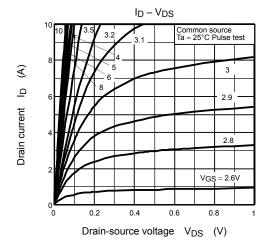


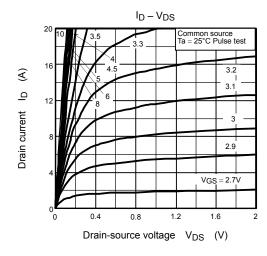
## **Electrical Characteristics (Ta = 25°C)**

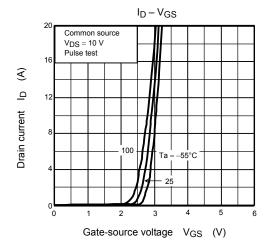
Ch	aracteristic	Symbol	Test Condition	Test Condition Min Typ. Max		Unit	
Gate leakage cur	rent	I <sub>GSS</sub>	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$		_	±10	μА
Drain cutoff curre	ent	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V	_	_	10	μА
Drain source bro	akdowa voltogo	$V_{(BR)DSS}$ $I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$		30	_	_	V
Dialii-Source bre	akdown voltage	V (BR) DSX	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	15	2.3 9.5 13 6.8 9 32 - 1395 -	V	
Gate threshold vo	oltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.1	_	2.3	V
Drain-source ON	raciatanaa	Dec (cu)	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 6.5 A	_	9.5	13	
Diain-source ON	-resistance	R <sub>DS</sub> (ON)	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6.5 A	_	—     6.8     9       16     32     —       —     1395     —       —     140     —		mΩ
Forward transfer	admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 6.5 A	16 32 —		_	S
Input capacitance	nput capacitance			_	1395	_	
Reverse transfer	capacitance	C <sub>rss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	140	_	pF
Output capacitance		C <sub>oss</sub>	_	_	525	_	
Switching time	Rise time	t <sub>r</sub>	V <sub>GS</sub> 10 V   I <sub>D</sub> = 6.5 A   C <sub>S</sub>   C <sub></sub>	_	3	_	- ns
	Turn-on time	t <sub>on</sub>		_	9	_	
	Fall time	t <sub>f</sub>		_	8	_	
	Turn-off time	t <sub>off</sub>	$V_{DD} \simeq 15 \text{ V}$ Duty $\leq$ 1%, $t_W = 10 \mu\text{s}$	_	29	_	
Total gate charge	<del>.</del>	0	$V_{DD} \simeq 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 13 \text{ A}$	_	—     23     —       —     13     —		
(gate-source plus	gate-drain)	Qg	$V_{DD} \simeq 24 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 13 \text{ A}$	_			nC
Gate-source charge 1		Q <sub>gs1</sub>	$V_{DD} \simeq 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 13 \text{ A}$	_	4.5	_	
Gate-drain ("Miller") charge		Q <sub>gd</sub>		_	4.9	_	
Gate switch charge		Q <sub>SW</sub>	1	_	6.9	_	

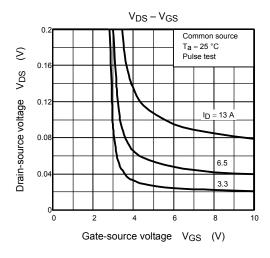
# Source-Drain Ratings and Characteristics (Ta = 25°C)

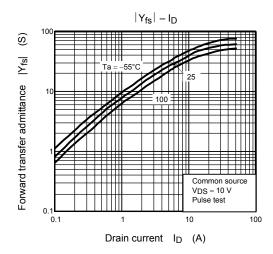
Characteri	stic		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse	(Note 1)	I <sub>DRP</sub>	_	_	_	52	Α
Forward voltage (diode)			V <sub>DSF</sub>	I <sub>DR</sub> = 13 A, V <sub>GS</sub> = 0 V	_	_	-1.2	V

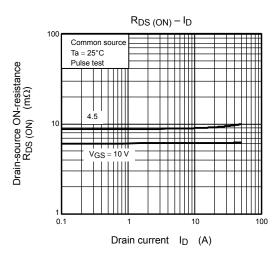


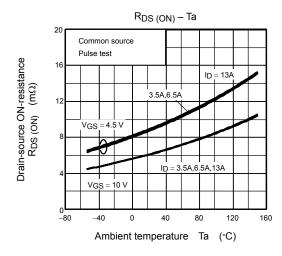


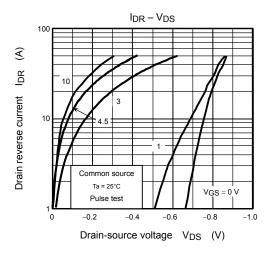


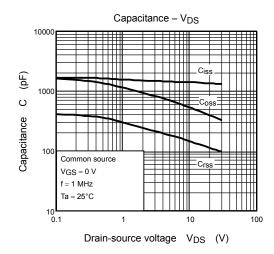


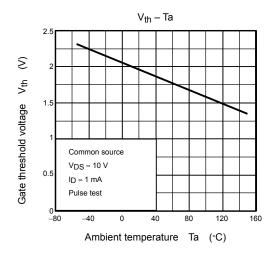


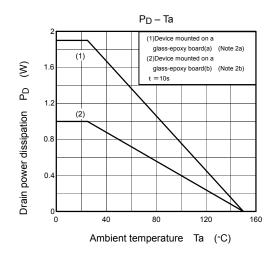


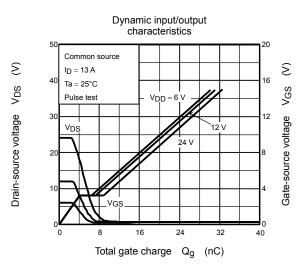




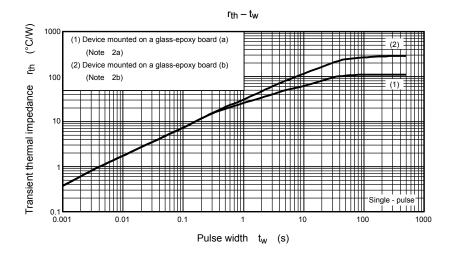


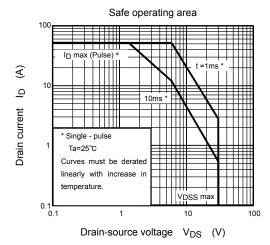






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